



(1,27mm) .050"

**SEAF SERIES** 



## HIGH SPEED/HIGH DE OPEN PIN FIELD

### **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?SEAF

Insulator Material:

Black LCP
Contact Material:
Copper Alloy Solder Charge:

95.5% Sn, 3.8% Ag, 0.7% Cu (Tin/Lead also available. Call Samtec.)

Operating Temp Range: -55°C to +125°C

8 8

8

8

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8

8

8

8

8

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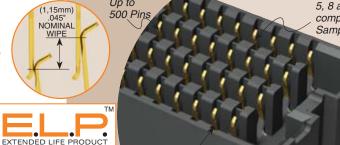
8

Plating: Au or Sn over 50μ" (1,27μm) Ni Contact Resistance:  $5.5~\text{m}\Omega$ 

Working Voltage:

RoHS Compliant: Yes Lead-Free Solderable: Yes Mates with: SEAM, SADL SEAMP, SEAR, SEAMI, **SEAC** (Requires -LP)





5, 8 and 10 row footprint compatible with SamArray®. Samples recommended.

> Solder charges

Call Samtec for maximum cycles mated with SEAM

10 year Mixed Flowing Gas with 30µ" Gold

Low Insertion/ Extraction Forces 7mm Stack Height Rated @ 3dB Insertion Loss Single-Ended Signaling 9.5 GHz / 19 Gbps Differential Pair Signaling 10.5 GHz / 21 Gbps

Performance data for other stack heights and complete test data available at www.samtec.com?SEAF or contact sig@samtec.com

CURRENT RATING AMBIENT SEAM/SEAF TEMP 2.3A 20°C 40°C 2A 60°C 1.75A 95°C 1.14A 30 ADJACENT POSITIONS POWERED

PISMO 2

VITA 47 VITA 57

Fibre Channel Rapid 1/0 PCI Express® SATA Infiniband

Download app notes at www.samtec.com/appnote Contact SIG @ samtec.com for questions on protocols

NO. PINS **SEAF** PER ROW

> **LEAD STYLE** from

**LEAD** 

STYLE

<u> </u>		
D LE	Α	
.0	(5,05) .199	
.0	(6,05) .238	
.5	(6,55) .258	
. <b>5</b> only)	(7,54) .297	
.0	(8,05) .317	

STY

-05

-06

-06

**-07** (30x4

-08

-10, -15, -20, -30, -40, -50 -10 only available in 04 row) -15 only available in 10 row) chart

NO. OF ROWS	В
-04.0	(5,61) .221
-05, -06	(8,20) .323
-08	(10,69) .421
-10	(13,23) .521

NO. OF PLATING **OPTION ROWS** -04

=Five

Rows

-06

Rows

-08

=Eight

Rows

 $= 10 \mu$ " (0,25µm) Gold on contact area Matte Tin on solder tail

-S = 30µ" (0,76µm) Gold on contact area Matte Tin on solder tail

=Four 2 Rows = Lead-Free Solder Charge -05

-LP = Latch Post (-LP required for SEAC mate only)

#### **ALSO AVAILABLE**

OPTION

Rugged solder crimp option. Call Samtec.

DIFFERENTIAL								
- (1,27) .050			ARRAY	PAIR COUNT				
1,27)			40x8	80				
			40x6	60				
<b>★</b> • • • • •			30x10	75				
	PAIR	ı	30x8	60				
ARRAY	COUNT		30x6	45				
50x10	125		20x10	50				

20x8

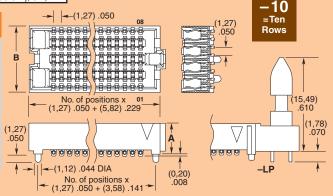
20x5

40

25

Note: Some sizes, styles and options are non-standard, non-returnable.

100



SEAM	SEAF LEAD STYLE						
LEAD STYLE	-05.0	-06.0	-06.5	-07.5	-08.0		
-02.0	7mm	8mm	8.5mm	9.5mm	10mm		
-03.0	8mm	9mm	9.5mm	10.5mm	11mm		
-03.5	8.5mm	9.5mm	10mm	11mm	11.5mm		
-06.5	11.5mm	12.5mm	13mm	14mm	14.5mm		
-07.0	12mm	13mm	13.5mm	14.5mm	15mm		
-09.0	14mm	15mm	15.5mm	16.5mm	17mm		
-11.0	16mm	17mm	17.5mm	18.5mm	19mm		

MATED HEIGHTS

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM

50x8

40x10









(1,27mm) .050" SEAF-RA SERIES

# **HI-DENSITY RIGHT ANGLE OPEN PIN FIELD**

#### **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?SEAF-RA

Insulator Material:
Black LCP
Contact Material:
Copper Alloy
Current Rating:
2.1 A with 4 adjacent contacts powered
Operating Temp Range:
-55°C to +125°C
Plating:
Au or Sn over 50µ" (1,27µm) Ni

Au or Sn over 50μ" (1,27μm) N
Contact Resistance:
17.1 mΩ max

Working Voltage: 280 VAC Mated Cycles:

RoHS Compliant:

Lead-Free Solderable: Yes Mates with:
SEAM, SADL,
SEAC (Requires –LP)

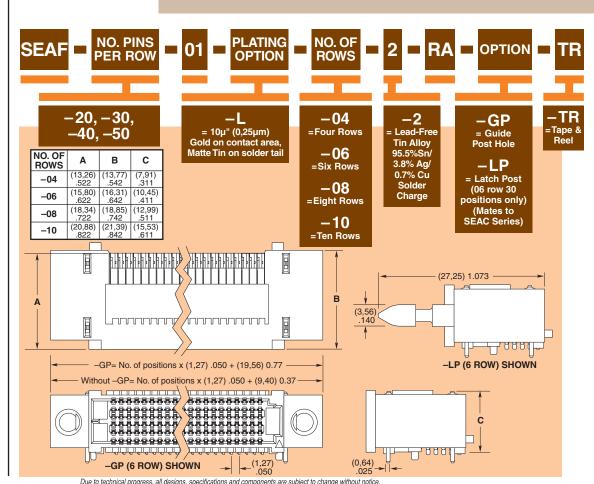
RUGGED ZED

SAMTEC

• Guide post holes

Low Insertion/
Extraction Forces

Optional
Guide Post holes



**Note:** Other Gold plating options available. Contact Samtec.

**Note:** Some sizes, styles and options are non-standard, non-returnable.

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